



TITLE: BUMP CHIP LEAD FRAME AND PACKAGE  
INVENTOR: Hung V. Ngo  
SERIAL NO.: 09/736462 - DOCKET NO.: ONSSC0853AM  
REPLACEMENT SHEET

Approved  
1-10-05  
HVN

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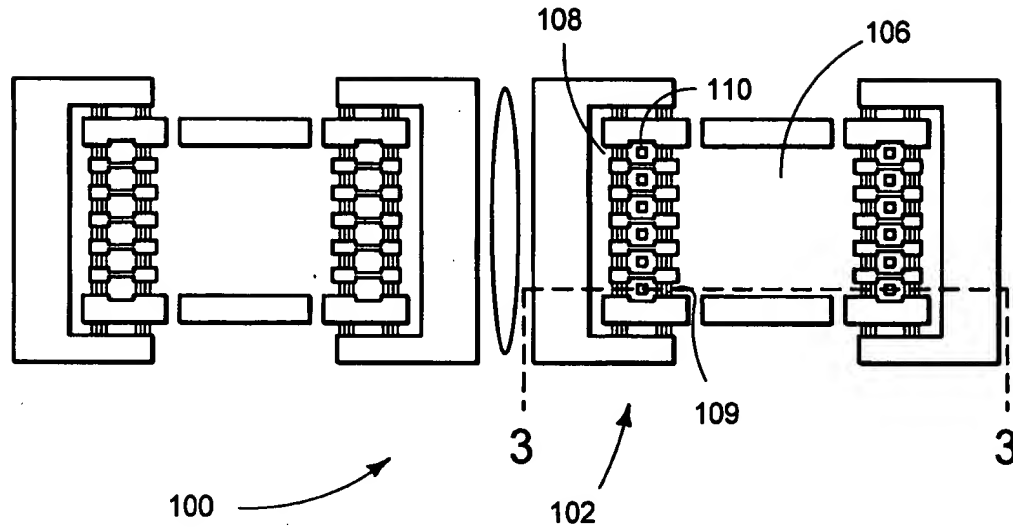


FIG. 1

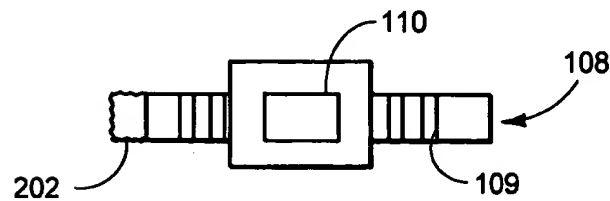
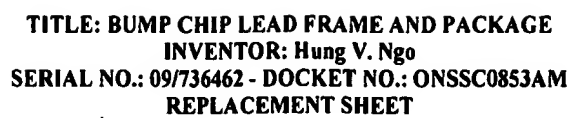


FIG. 2



**FIG. 3B**



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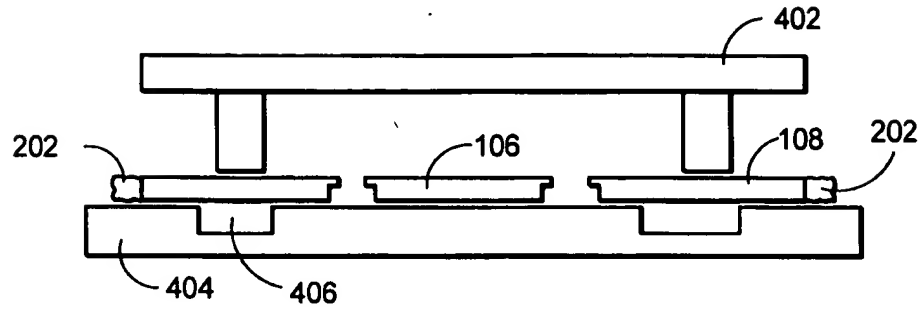


FIG. 4A

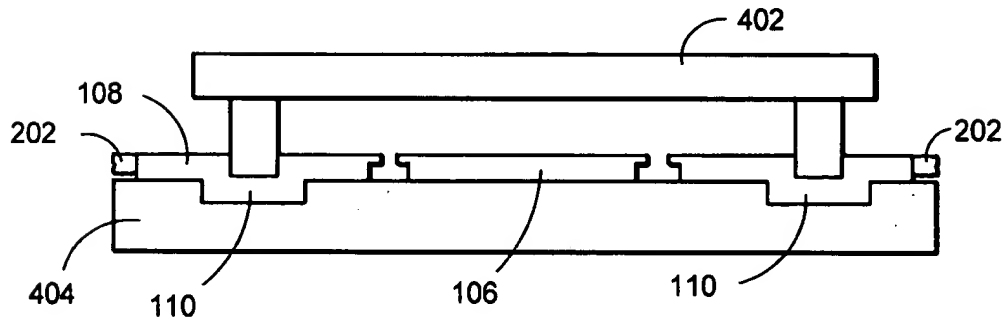


FIG. 4B

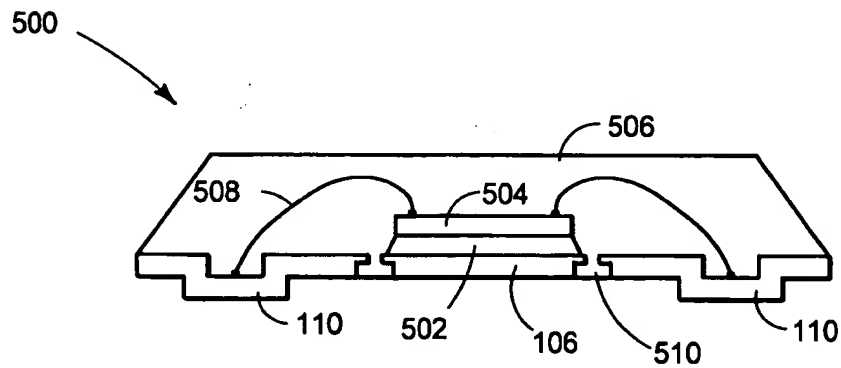


FIG. 5



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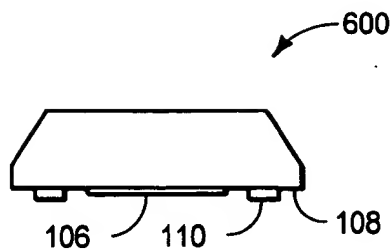


FIG. 6A

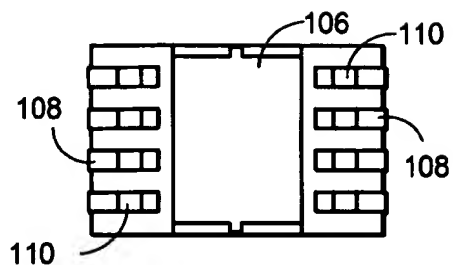


FIG. 6B

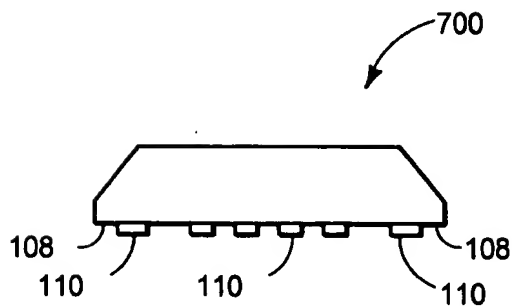


FIG. 7A

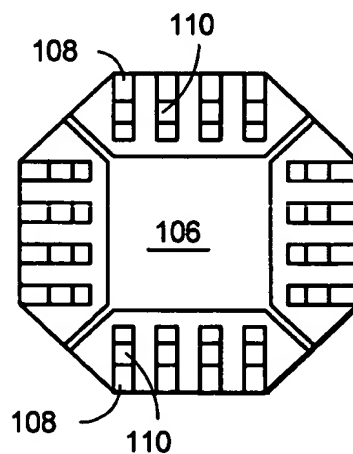


FIG. 7B



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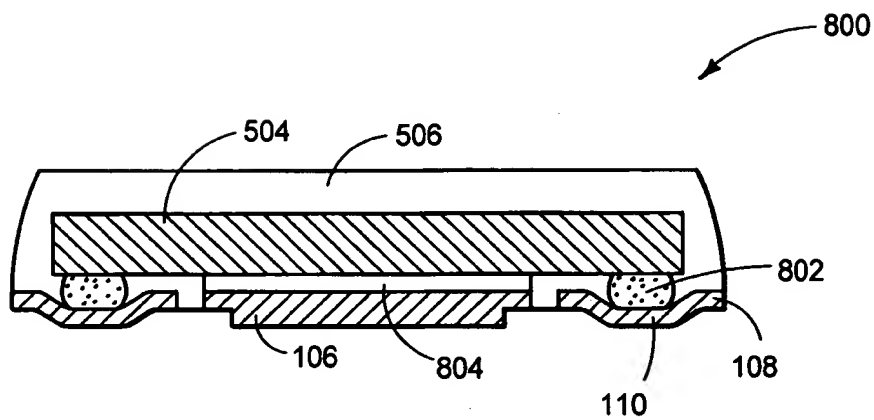


FIG. 8